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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/723,714 : Confirmation No.: 9797  
Applicant : Bing Ji et al.  
Filed : November 26, 2003  
For : METHOD FOR ETCHING HIGH DIELECTRIC CONSTANT  
MATERIALS AND FOR CLEANING DEPOSITION CHAMBERS FOR  
HIGH DIELECTRIC MATERIALS

Art Unit : 1763  
Examiner : George A. Goudreau

Docket No. : 06299P2USA  
Customer No. : 23543

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

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**Amendment and Response to Non-Final Office Action**

Sir:

The following is responsive to the Office Action dated June 2, 2004:

- ☐ **Amendments to the Specification** begin on page \_\_\_\_\_ of this paper.
- ☒ **Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.
- ☐ **Amendments to the Drawings** begin on page \_\_\_\_\_ of this paper and include an attached replacement sheet(s).
- ☐ **Amendments to the Abstract** are on page \_\_\_\_\_ of this paper. A clean version of the Abstract is on page \_\_\_\_\_ of this paper.
- ☒ **Remarks/Arguments** begin on page 7 of this paper.